RELATED GOVERNMENT PROCUREMENT. THE UNITED STATES GOVERNMENT MAY HAVE FORMULATED, FURNISHED, OR SUPPORTED THE RESEARCH AND DEVELOPMENT OF THE GOODS, SERVICES, OR TECHNOLOGY COVERED BY THIS INVENTION, AND THE UNITED STATES GOVERNMENT THEREFORE INCURS NO RESPONSIBILITY OR OBLIGATION WHATSOEVER.

1. GENERAL:
A. INTERPRET DRAWING IN ACCORDANCE WITH STANDARDS PRESCRIBED IN MIL-D-7037.
B. UNITS SHALL MEET THE REQUIREMENTS OF MIL-C-11272, OPERATING TEMPERATURE C, TOLERANCE ±, EXCEPT AS AND IN ADDITION TO THE REQUIREMENTS SPECIFIED HEREIN.
C. SUPPLIERS SHALL CONFORM TO THE QUALITY ASSURANCE PROVISIONS AS CONTAINED IN MIL 1015404, CLASS 2.
D. UNITS SHALL MEET THE QUALIFICATION REQUIREMENTS OF NO 1002034.
F. ACCURACY AND INSPECTION:
A. LEAD MATERIAL SHALL BE GOLD-PLATED DUMET PER THE FOLLOWING REQUIREMENTS:
   1. Lead Composition: 36.2% Ni, 0.2% Cu, 0.02% Mo, 0.03% W, 0.03% Si, 0.02% P, 1.50% Residuals
   2. Lead Plating: ELECTROPLATED 24 KARAT GOLD, 50 MICROINCHES MINIMUM
   3. Lead Diameter: 0.008" ± 0.0005" (±0.001)

2. SPECIFICATIONS:
A. DIMENSIONS: PER MIL-D-7037, ELECTROPLATING:
   1. Electroplating: ELECTROPLATED 24 KARAT GOLD, 50 MICROINCHES MINIMUM
   2. Lead Diameter: 0.008" ± 0.0005" (±0.001)
   3. Lead Material: ELECTROPLATED 24 KARAT GOLD, 50 MICROINCHES MINIMUM
   4. Lead Composition: 36.2% Ni, 0.2% Cu, 0.02% Mo, 0.03% W, 0.03% Si, 0.02% P, 1.50% Residuals
   5. Lead Plating: ELECTROPLATED 24 KARAT GOLD, 50 MICROINCHES MINIMUM

TABLE I

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LEADS TO BE LOCATED ON SHEET 1 OF 2